



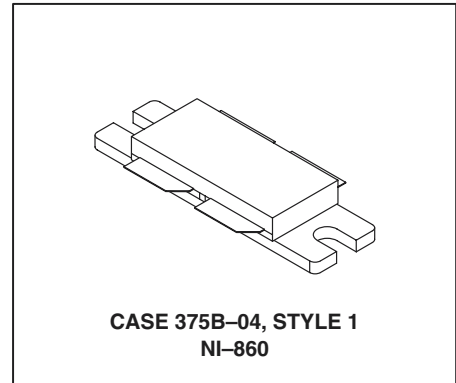
The RF MOSFET Line  
**RF Power Field-Effect Transistor**  
N-Channel Enhancement-Mode Lateral MOSFET

**MRF186**

Designed for broadband commercial and industrial applications with frequencies from 800 MHz to 1.0 GHz. The high gain and broadband performance of this device make it ideal for large-signal, common source amplifier applications in 28 volt base station equipment.

**1.0 GHz, 120 W, 28 V  
LATERAL N-CHANNEL  
BROADBAND  
RF POWER MOSFET**

- Guaranteed Performance @ 960 MHz, 28 Volts  
Output Power — 120 Watts PEP  
Power Gain — 11 dB  
Efficiency — 30%  
Intermodulation Distortion — -28 dBc
- Excellent Thermal Stability
- 100% Tested for Load Mismatch Stress at all Phase Angles with 5:1 VSWR @ 28 Vdc, 960 MHz, 120 Watts CW



**MAXIMUM RATINGS (2)**

Rating	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	65	Vdc
Drain-Gate Voltage ( $R_{GS} = 1 \text{ M}\Omega$ )	$V_{DGR}$	65	Vdc
Gate-Source Voltage	$V_{GS}$	$\pm 20$	Vdc
Drain Current — Continuous	$I_D$	14	Adc
Total Device Dissipation @ $T_C = 70^\circ\text{C}$ Derate above $70^\circ\text{C}$	$P_D$	162.5 1.25	Watts W/ $^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	- 65 to +150	$^\circ\text{C}$
Operating Junction Temperature	$T_J$	200	$^\circ\text{C}$

**THERMAL CHARACTERISTICS (2)**

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.8	$^\circ\text{C}/\text{W}$

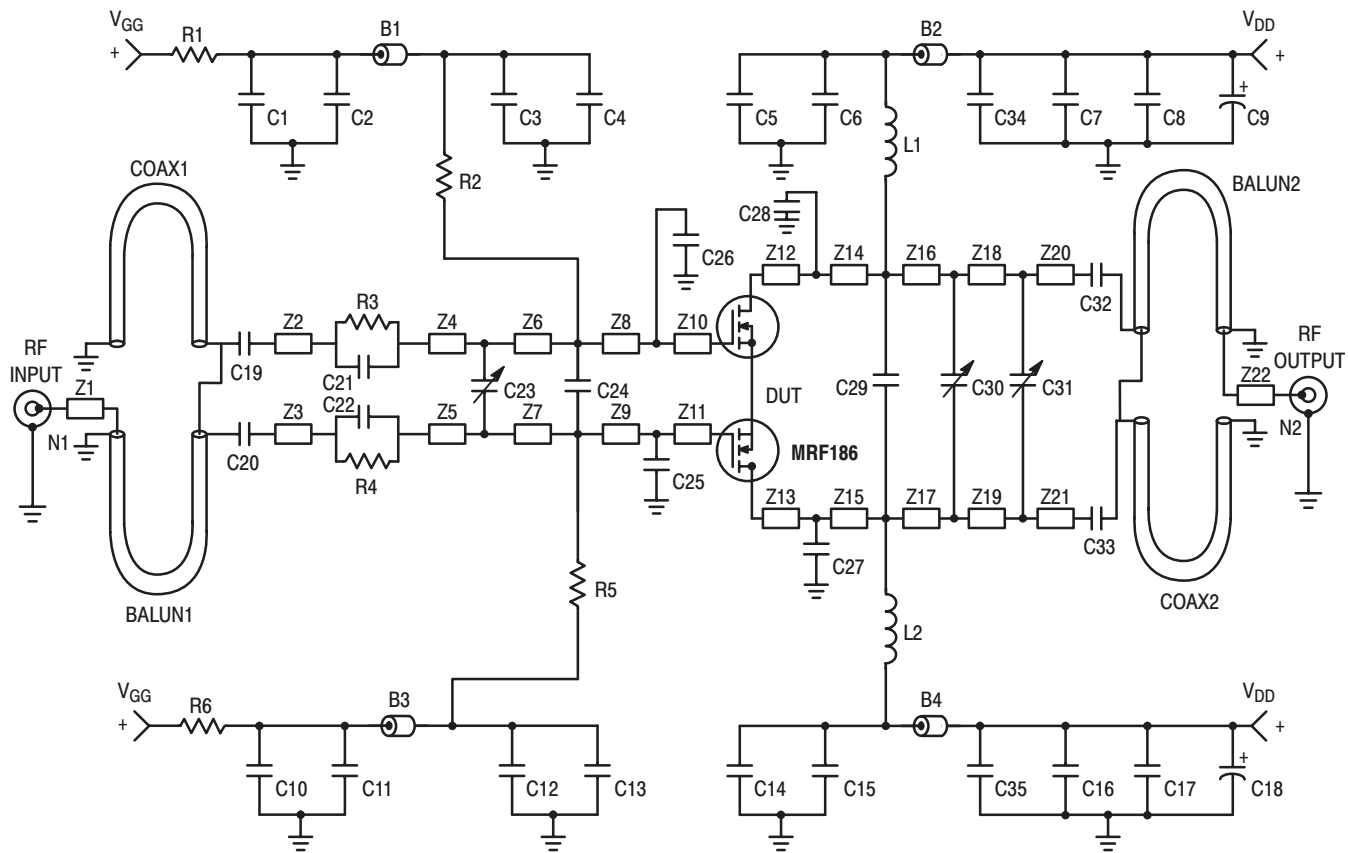
NOTE – **CAUTION** – MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

**ELECTRICAL CHARACTERISTICS** ( $T_C = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS (1)</b>					
Drain–Source Breakdown Voltage ( $V_{GS} = 0 \text{ Vdc}$ , $I_D = 50 \mu\text{Adc}$ )	$V_{(BR)DSS}$	65	—	—	Vdc
Zero Gate Voltage Drain Current ( $V_{DS} = 28 \text{ Vdc}$ , $V_{GS} = 0 \text{ Vdc}$ )	$I_{DSS}$	—	—	1	$\mu\text{Adc}$
Gate–Source Leakage Current ( $V_{GS} = 20 \text{ Vdc}$ , $V_{DS} = 0 \text{ Vdc}$ )	$I_{GSS}$	—	—	1	$\mu\text{Adc}$
<b>ON CHARACTERISTICS (1)</b>					
Gate Quiescent Voltage ( $V_{DS} = 26 \text{ Vdc}$ , $I_D = 300 \mu\text{Adc}$ Per Side)	$V_{GS(th)}$	2.5	3	4	Vdc
Gate Quiescent Voltage ( $V_{DS} = 26 \text{ Vdc}$ , $I_D = 300 \text{ mAdc}$ Per Side)	$V_{GS(Q)}$	3.3	4.2	5	Vdc
Delta Gate Threshold Voltage (Side to Side) ( $V_{DS} = 28 \text{ V}$ , $I_D = 300 \text{ mA}$ Per Side)	$\Delta V_{GS(Q)}$	—	—	0.3	Vdc
Drain–Source On–Voltage ( $V_{GS} = 10 \text{ Vdc}$ , $I_D = 3 \text{ Adc}$ Per Side)	$V_{DS(on)}$	—	0.58	0.7	Vdc
Forward Transconductance ( $V_{DS} = 10 \text{ Vdc}$ , $I_D = 3 \text{ Adc}$ Per Side)	$g_{fs}$	2.4	2.8	—	S
<b>DYNAMIC CHARACTERISTICS (1)</b>					
Input Capacitance (Per Side) ( $V_{DS} = 28 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1 \text{ MHz}$ )	$C_{iss}$	—	177	—	pF
Output Capacitance (Per Side) ( $V_{DS} = 28 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1 \text{ MHz}$ )	$C_{oss}$	—	45	—	pF
Reverse Transfer Capacitance (Per Side) ( $V_{DS} = 28 \text{ Vdc}$ , $V_{GS} = 0$ , $f = 1 \text{ MHz}$ )	$C_{rss}$	—	3.4	—	pF
<b>FUNCTIONAL CHARACTERISTICS (In Motorola Test Fixture, 50 ohm system) (2)</b>					
Two–Tone Common Source Amplifier Power Gain ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 960.0 \text{ MHz}$ , $f_2 = 960.1 \text{ MHz}$ )	$G_{ps}$	11	12.2	—	dB
Two–Tone Drain Efficiency ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 960.0 \text{ MHz}$ , $f_2 = 960.1 \text{ MHz}$ )	$\eta$	30	35	—	%
3rd Order Intermodulation Distortion ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 960.0 \text{ MHz}$ , $f_2 = 960.1 \text{ MHz}$ )	IMD	—	–32	–28	dBc
Input Return Loss ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 960.0 \text{ MHz}$ , $f_2 = 960.1 \text{ MHz}$ )	IRL	9	16	—	dB
Two–Tone Common Source Amplifier Power Gain ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 945.0 \text{ MHz}$ , $f_2 = 945.1 \text{ MHz}$ )	$G_{ps}$	—	12	—	dB
Two–Tone Drain Efficiency ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 945.0 \text{ MHz}$ , $f_2 = 945.1 \text{ MHz}$ )	$\eta$	—	33	—	%
3rd Order Intermodulation Distortion ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 945.0 \text{ MHz}$ , $f_2 = 945.1 \text{ MHz}$ )	IMD	—	–32	—	dBc
Input Return Loss ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W PEP}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f_1 = 945.0 \text{ MHz}$ , $f_2 = 945.1 \text{ MHz}$ )	IRL	—	16	—	dB
Output Mismatch Stress ( $V_{DD} = 28 \text{ Vdc}$ , $P_{out} = 120 \text{ W CW}$ , $I_{DQ} = 2 \times 400 \text{ mA}$ , $f = 960 \text{ MHz}$ , $VSWR = 5:1$ , All Phase Angles at Frequency of Tests)	$\Psi$	No Degradation In Output Power Before and After Test			

(1) Each side of device measured separately.

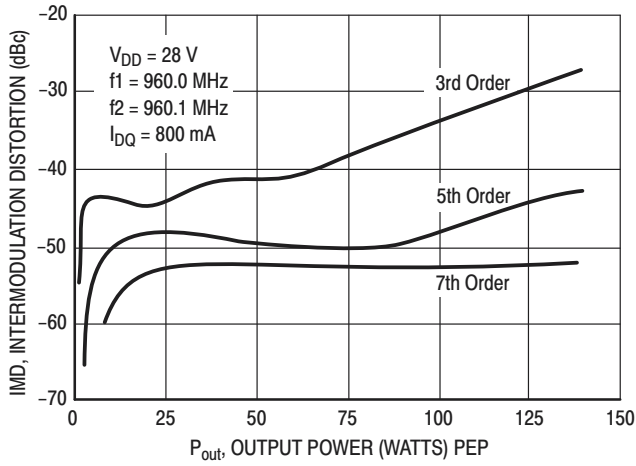
(2) Device measured in push–pull configuration.



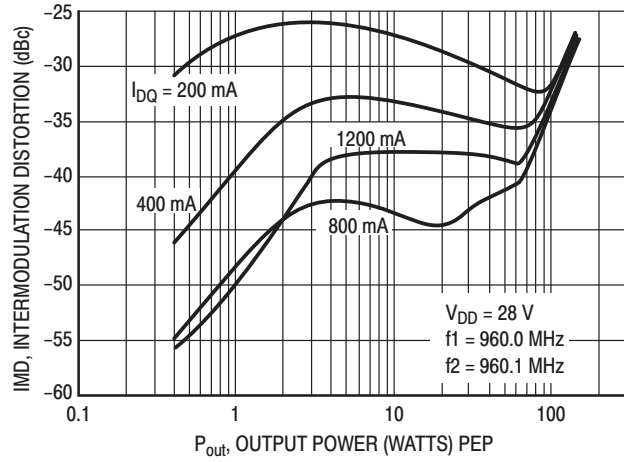
- |                           |   |                 |   |
|---------------------------|---|-----------------|---|
| B1 – B4                   | Fair Rite Products Short Ferrite Bead, 2743021446   | C31             | 0.8 – 8.0 pF, Variable Capacitor, Johanson Gigatrim   |
| C1, C7, C8, C10, C16, C17 | 10 $\mu$ F, 50 V, Tantalum                          | L1, L2          | 3 Turns, #20 AWG, IDIA 0.126", 24.7 nH                |
| C2, C11, C34, C35         | 0.1 $\mu$ F, Chip Capacitor                         | N1, N2          | Type N Connectors                                     |
| C3, C6, C12, C15          | 330 pF, Chip Capacitor                              | R1, R6          | 1 k $\Omega$ , 1/4 W, Carbon Resistor                 |
| C4, C5, C13, C14,         |   | R2, R5          | 1.2 k $\Omega$ , 0.1 W, Chip Resistor                 |
| C19, C20, C32, C33        | 47 pF, Chip Capacitor                               | R3, R4          | 75 $\Omega$ , 0.1 W, Chip Resistor                    |
| C9, C18                   | 250 $\mu$ F, 50 V, Electrolytic Capacitor           | Z1 – Z22        | Microstrip (See Component Placement)                  |
| C21, C22                  | 12 pF, Chip Capacitor                               | Balun1, Balun2, |   |
| C23, C30                  | 0.6 – 4.5 pF, Variable Capacitor, Johanson Gigatrim | Coax1, Coax2    | 2.20" 50 $\Omega$ , 0.086" OD Semi-Rigid Coax         |
| C24, C25, C26             | 5.1 pF, Chip Capacitor                              | Board           | 1/32" Glass Teflon <sup>®</sup> , $\epsilon_r = 2.55$ |
| C27, C28                  | 3.9 pF, Chip Capacitor                              |                 |   |

Figure 1. 930 – 960 MHz Test Circuit Schematic

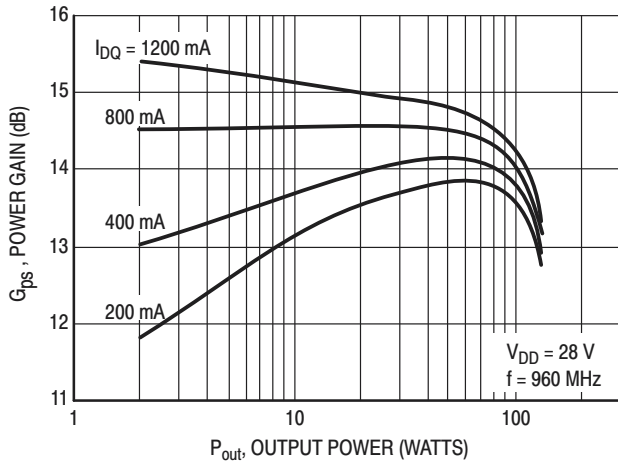
**TYPICAL CHARACTERISTICS**



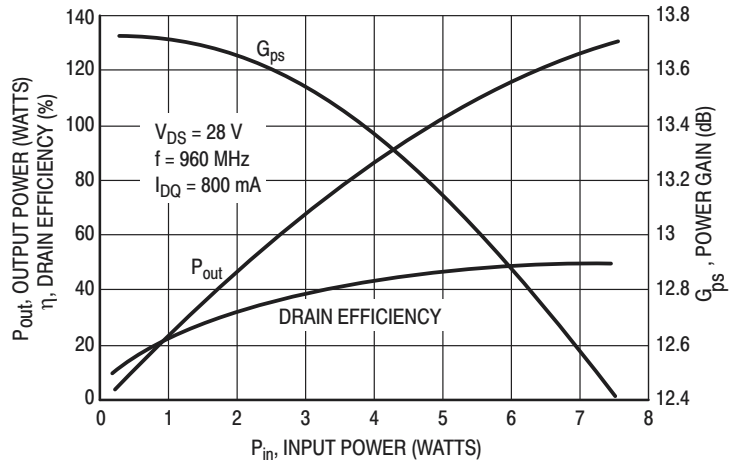
**Figure 2. Intermodulation Distortion Products versus Output Power**



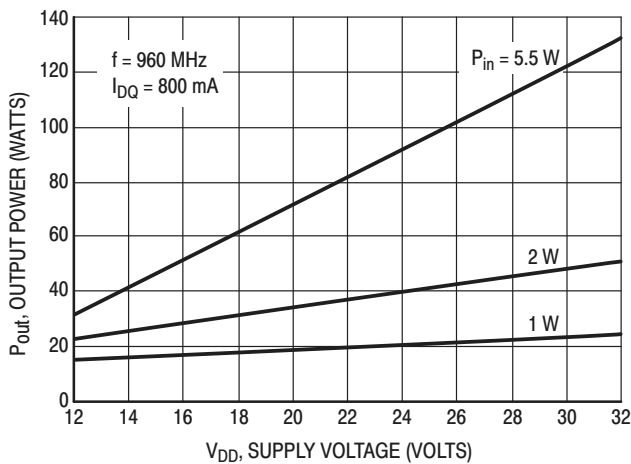
**Figure 3. Intermodulation Distortion versus Output Power**



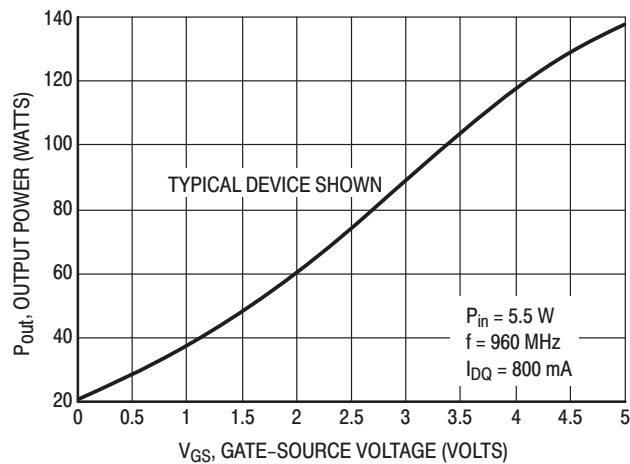
**Figure 4. Power Gain versus Output Power**



**Figure 5. Output Power versus Input Power**



**Figure 6. Output Power versus Supply Voltage**



**Figure 7. Output Power versus Gate Voltage**

ARCHIVED 2005



TYPICAL CHARACTERISTICS

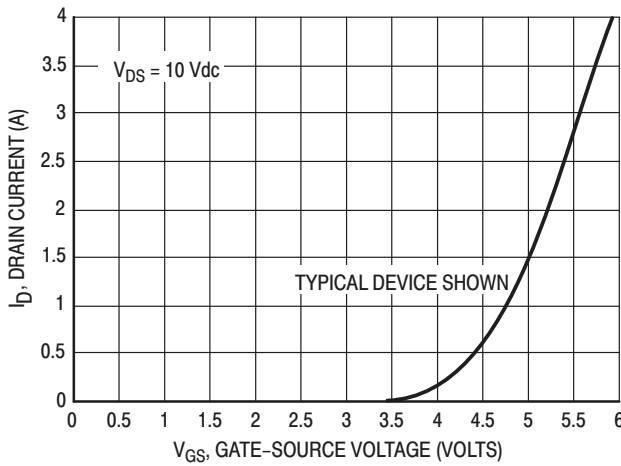


Figure 8. Drain Current versus Gate Voltage

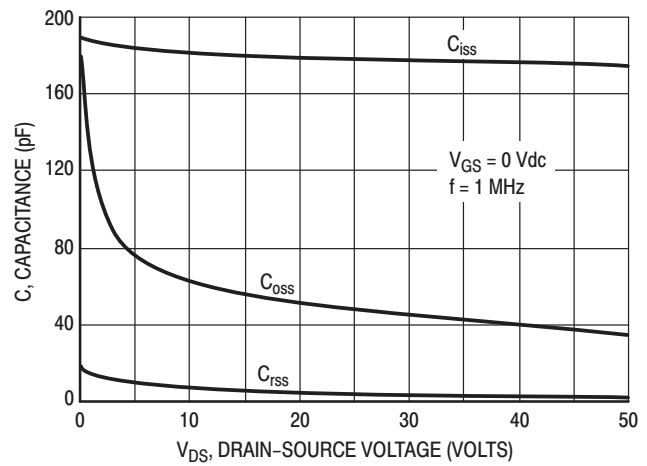


Figure 9. Capacitance versus Voltage

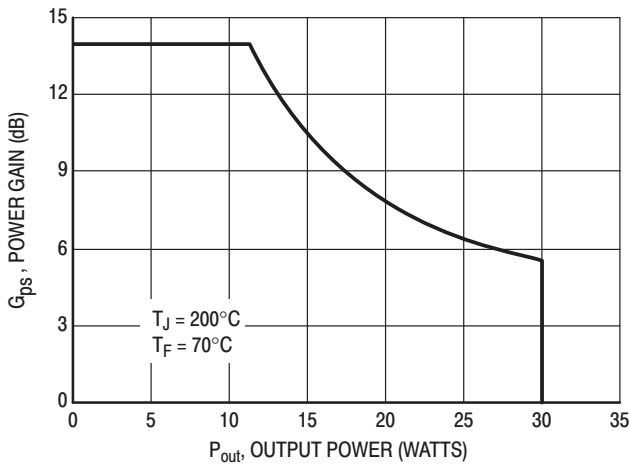


Figure 10. DC Safe Operating Area

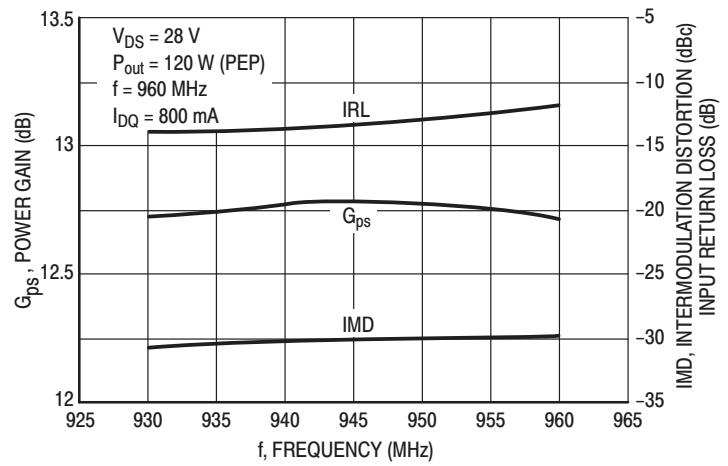
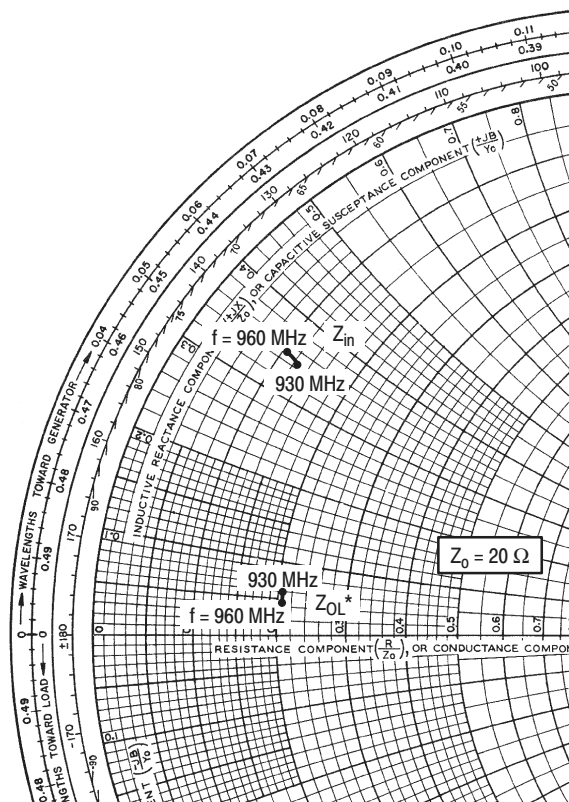


Figure 11. Broadband Circuit Performance

ARCHIVED 2005



$V_{CC} = 28 \text{ V}$ ,  $I_{DQ} = 2 \times 400 \text{ mA}$ ,  $P_{out} = 120 \text{ W PEP}$

f MHz	$Z_{in}$ $\Omega$	$Z_{OL}^*$ $\Omega$
930	$2.5 + j6.9$	$4.3 + j1.2$
945	$2.5 + j7.0$	$4.3 + j1.0$
960	$2.2 + j7.1$	$4.3 + j0.9$

$Z_{in}$  = Complex conjugate of source impedance.

$Z_{OL}^*$  = Conjugate of the optimum load impedance at a given output power, voltage, IMD, bias current, efficiency and frequency.

Note:  $Z_{OL}^*$  was chosen based on tradeoffs between gain, output power, drain efficiency and intermodulation performance. Impedances shown represent a single channel (1/2 of MRF186) impedance measurement.

Figure 12. Series Equivalent Input and Output Impedance



ARCHIVED 2005

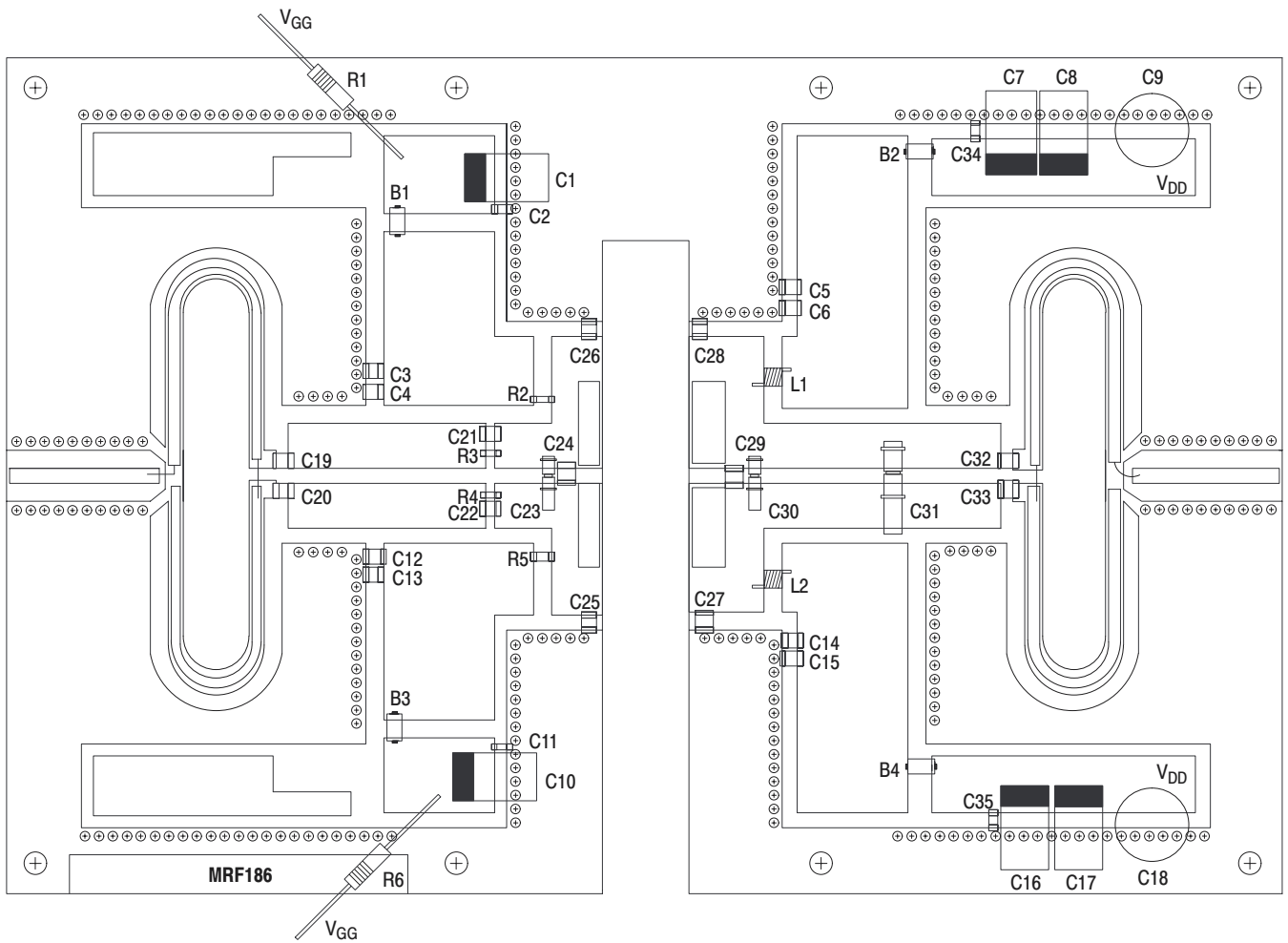
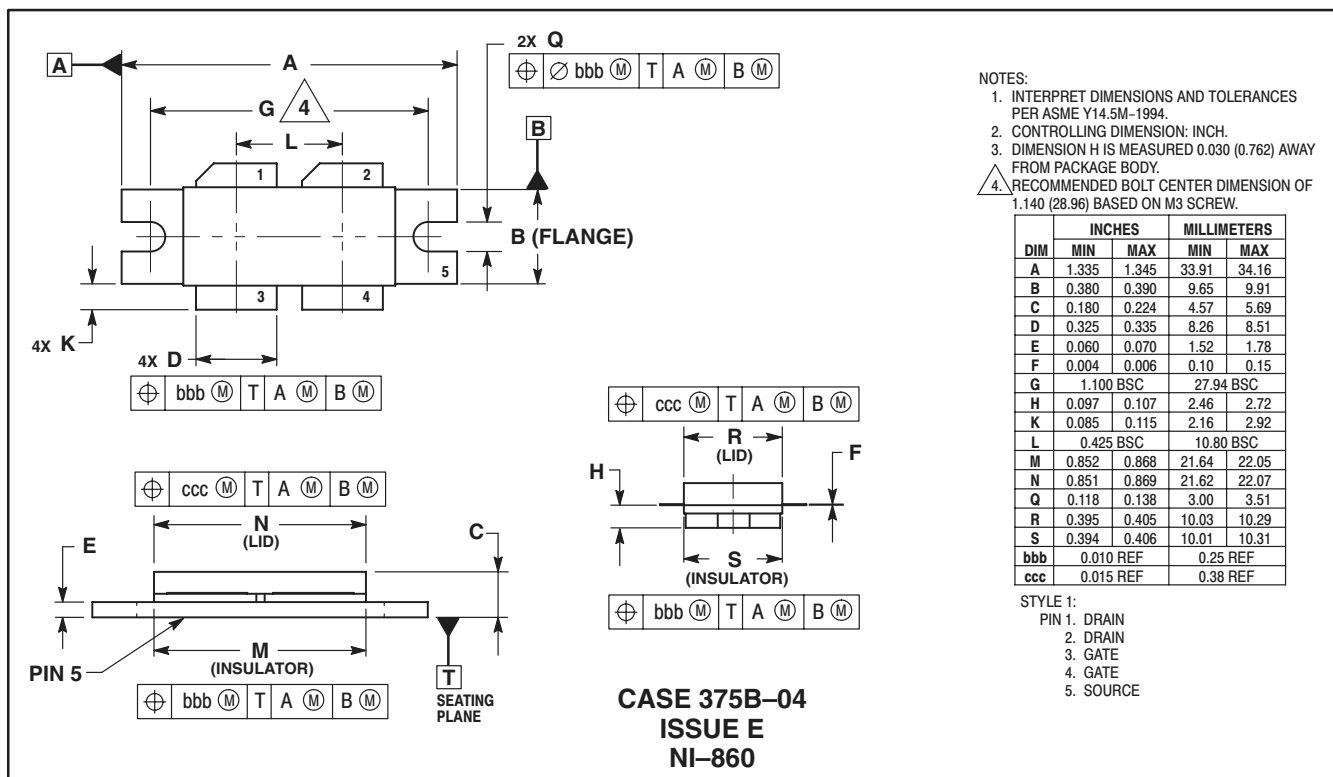


Figure 13. Component Placement Diagram of 930 - 960 MHz Broadband Test Fixture



PACKAGE DIMENSIONS



ARCHIVED 2005

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation, or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals", must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola and the Stylized M Logo are registered in the US Patent & Trademark Office. All other product or service names are the property of their respective owners. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

© Motorola, Inc. 2002.

**How to reach us:**

**USA/EUROPE/Locations Not Listed:** Motorola Literature Distribution; P.O. Box 5405, Denver, Colorado 80217. 1-303-675-2140 or 1-800-441-2447

**JAPAN:** Motorola Japan Ltd.; SPS, Technical Information Center, 3-20-1, Minami-Azabu. Minato-ku, Tokyo 106-8573 Japan. 81-3-3440-3569

**ASIA/PACIFIC:** Motorola Semiconductors H.K. Ltd.; Silicon Harbour Centre, 2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T. Hong Kong. 852-2668334

**Technical Information Center: 1-800-521-6274**

**HOME PAGE:** <http://www.motorola.com/semiconductors/>



MRF186/D

Archived 2005